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- (54) ELECTRICALLY CONDUCTIVE ANTI-REFLECTION COATING
 ELEKTRISCH LEITENDER ANTIREFLEXIONSSCHICHT
 REVETEMENT ANTIREFLET ET ELECTROCONDUCTEUR
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US-A-5 372 874

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 - PATENT ABSTRACTS OF JAPAN vol. 012, no. 114 (P-688), 12 April 1988 & JP 62 244001 A (ALPS ELECTRIC CO LTD), 24 October 1987

EP 0 834 092 B1

Description

Field of the Invention

[0001] The present invention relates to anti-reflection coatings for transparent substrates such as ophthalmic lens and particularly to a method of fabricating anti-reflection coatings that are anti-static and easy to clean.

Background of the Invention

0002] Ophthalmic lenses have traditionally been formed as a single integral body of glass or plastic. Recently, lenses have been fabricated by laminating two lens wafers together with transparent adhesive. Regardless of how it is constructed, an ophthalmic lens can include an anti-reflection.coating to improve transmittance of visible light.

[0003] Conventional anti-refiscion coatings comprise multilayer structures described for instance, in U.S. Patents 4,342,225 and 3,565,509. Conventional anti-reflection coatings have a hydrophobic outer layer, which typically comprises a fluoroality/chlorosilane, to promote soil resistance and facilitate cleaning. Despite the presence of this outer layer, ophthalmic lens surfaces nevertheless tend to attract airborne particles. Furthermore, oil contaminants on the lens surface tend to smudge rather than whose off dealny, making the lenses difficult to maintain.

Summary of the Invention

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[0004] The present invention is directed to transparent articles such as ophthalmic lens that are coated with an antireflection coating with inherent anti-static properties. In addition to not attracting dust and other air-borne contaminants, the durable inventive anti-reflection coating is also easy to clean. Anti-reflection coatings of the present invention do not require a hydrophobic outer layer.

29 [0005] Subject matter of the present invention is a method of fabricating a high transmittance article as defined in claim 1, and a high transmittance article as defined in claim 8. The dependent claims relate to preferred embodiments thereof.

[0006] EP-A-0 203 790 relates to an anti-reflection optical article and process for the preparation thereof. The method for fabricating a high transmittance ophthalmic lens, comprising providing a transparent substrate and forming on a surface of said substrate a transparent anti-reflection coaling. In order to obtain an antistatic effect as well as an anti-reflection effect, at least one layer of the multilayer film should be electro-conductive.

[0007] US-A-5,362,552 relatas to anti-reflection coatings for visible light, and a substrate, such as protective antigiare screens for video display units having a transparent electrically conductive anti-reflection coating. The electrically conductive layers are made up of metal oxides in stoichiometric ratios, which optionally are dooded by heteroatoms.

[0008] Accordingly, one aspect of the invention is directed to a method of fabricating a high transmittance article which comprises the steps of; providing a transparent substrate; and forming, on a surface of said substrate, a transparent, electrically conductive anti-reflection coating, wherein the step of forming said coating comprises reading metal with non-stoichiometric amounts of oxygen such that the coating comprises one or more layers of electrically conductive metal oxide material.

40 [0009] According to one embodiment, the invention is directed to a method of fabricating a high transmittance article which comprises the steps of:

providing a transparent substrate; and

forming, on a surface of said substrate, a transparent multilayer anti-reflection coating wherein at least one layer comprises an electrically conductive high refractive index material or an electrically conductive low refractive index material.

[0010] According to the invention the coating is formed by reacting metal with non-stoichiometric amounts of oxygen such that the coating comprises one or more layers of electrically conductive metal oxide material. Techniques for accomplishing this include electron beam reactive evaporation, ion-assisted deposition, and reactive sputtering of metal targets.

[0011] In another aspect, the invention is directed to a high transmittance article as defined in claim 8. In one embodiment, the article comprises:

a transparent substrate; and

a transparent multilayer film comprising alternating layers of electrically conductive high refractive index and electrically conductive low refractive index materials.

[0012] In a further embodiment, the invention is directed to a substantially static resistant ophthalmic lens fabricated by a process that comprises the steps of:

providing a transparent substrate; and

depositing, onto a surface of said substrate, a transparent multilayer anti-reflection coating wherein each layer comprises an electrically conductive high refractive index or an electrically conductive low refractive index material.

[0013] In another embodiment, the invention is directed to a substantially anti-static ophthalmic lens fabricated by a process that comprises the steps of:

providing a transparent substrate; and

depositing, onto a surface of said substrate, a transparent multilayer film comprising alternating layers of high refractive index and low refractive index materials wherein each layer is electrically conductive.

15 [0014] In a preferred embodiment, the multilayer film comprises:

- (i) a first layer having an index of refraction from about 2.0 to about 2.55 and comprising a first metal oxide material; (ii) a second layer having an index of refraction from about 1.38 to about 1.5 and comprising a second metal oxide;
- (iii) a third layer having an index of refraction from about 2.0 to about 2.55 and comprising the first metal oxide material; and
 - (iv) a fourth layer having an index of refraction from about 1.38 to about 1.5 comprising the second metal oxide, wherein the indices of refraction are measured at a reference wavelength of 550 nanometers.

[0015] In a preferred embodiment, the third layer is electrically conductive. In yet another preferred embodiment, the first and third layers comprise high refractive index materials selected from the group consisting of titanium oxides niobium oxides, and tantalum oxides and the second and fourth layers comprise silicon dioxide. For substrates that comprise ophthalmic lens, the lens surface preferably has an electric potential that is less than about 100 volts.

Brief Description of the Drawings

[0016]

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Figure 1 is a partial cross-sectional view of an ophthalmic lens produced in accordance with this invention.

35 Figure 2 is a schematic diagram of an ion assisted deposition apparatus employed to produce the anti-reflection coating.

Figure 3 is a graph of electrostatic potential vs. layers in a coating.

Description of the Preferred Embodiments

[0017] The present invention is based in part on the discovery that increasing the electrical conductivity in one of more layers of a multilayer anti-reflection coating confers the coating with anti-static characteristics. Indeed, even whon subjected to frictional forces, the inventive anti-reflection coating does not develop any appreciable amount of electrostatic charge.

[0018] The inventive anti-reflection coating demonstrates improved resistance to dirt and stains as well, thereby obviating the need for employing a hydrophobic outer layer over the anti-reflection coating. The presence of this hydrophobic outer layer can adversely effect the optical characteristics of the ophthalmic lenses including, for instance, color consistency and reflectivity, and increase their production costs.

[0019] However, prior to describing the invention is further detail, the following terms will be defined:

[0020] The term "substrate" refers to a material which preferably has superior structural and optical properties. Crystalline quartz, fused silica, soda-lime silicate glass, and plastics such as from polymers based on allyl diglycol carbonate monomers (available as CR-39™ from PPG Industries, Inc., Hartford, Conn.) and polycarbonates such as Lexan™, available from General Electric Co, are preferred substrate materials. Substrates include aphthalmic lenses (including a similatesses) Preferred ophthalmic lenses also include laminated elenses that are fabricated by bonding two lens wafers (i.e., a front wafer and a back wafer) together with a transparent adhesive. Laminated lens wafers are described, for example, in U.S. Patent 5,149,181, 485,7553, and 4,645,317 and U.K. Patent Application, GB 2,260,937A. Commercially available plastic ophthalmic lenses that are coated with a polymeric scratch resistance coating that may be

about 1 µm to about 12 µm thick are also suitable substrates. The thickness of the polymeric scratch resistance coating will depend, in part, on the substrate material. Generally, plastic materials such as polycarbonates will require thicker coatings. Suitable substrates further include glass ophthalmic lenses, as described, for instance, in U.S. Patients 3,899,315 and 3,899,314. As used herein the term "lens" refers to both single integral body and laminated types.

[0021] The term "anti-reflection coating" or "AR coating" refers to a substantially transparent multilayer film that is applied to optical systems (e.g., surfaces thereof) to substantially eliminate reflection over a relatively wide portion of the visible spectrum, and thereby increase the transmission of light and reduce surface reflectance. Known ani-reflection coatings include multilayer films comprising elternating high and low refractive index materials (e.g., metal oxides) as described, for instance, in U.S. Patents 3,432,225, 3,565,509, 4,022,947, and 5,332,618. However, unlike prior art AR coatings, the inventive AR coatings employ one or more electrically conductive high andro electrically conductive low refractive index layers. The thickness of the AR coating will depend on the thickness of each individual layer in the multilayer film and the total number of layers in the multilayer film. The inventive AR coating can include any number of layers. Preferably, the AR coating for the ophthalmic lens has about 3 to about 12 layers, more preferably about 4 to about 7 layers, and most preferably about 4 layers. Preferably, the AR coating is about 100 to about 750 nm thick. For use with ooththalmic lenses, the AR coating is preferably about 22 to about 500 m thick of the superior and the coating is about 500 m thick of the superior and the coating is about 500 m thick.

[0022] The term "adhesion layer" refers to a film or coating that is formed on the transparent substrate prior to depositing the multilayer film of the anti-reflection coating. The adhesion layer promotes bonding of the anti-reflection coating to the substrate. Any suitable transparent material can be used to form the adhesion layer including chromlum oxide. Use of an adhesion layer is optional and the choice of material employed will depend, in part, on the substrate material and the material comprising the first layer of the multilayer anti-reflection coating. The thickness of the adhesion layer is not critical although it is preferably kept to a thickness just sufficient to effectively bond the substrate to the anti-reflection coating but not to have a significant optical effect. If the chromium is not oxidized sufficiently or if the anti-reflection coating but not to have a significant optical effect. If the chromium is not oxidized sufficiently or if the adhesion layer is too thick, then this layer will cause absorption of light and reduce transmission through the AR coating. The adhesion layer may be electrically conductive which may further enhance the anti-static characteristics of the multilayer anti-reflection coating.

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[0023] The term "high refractive index material" refers to materials having an index of refraction (at a referenced wavelength of about 550 nm) that is preferably greater than about 2.0, more preferably from about 2.1 to about 2.55, and most preferably from about 2.1 to about 2.4.

[0024] The term "low refractive index material" refers to materials having an index of refraction (at a referenced of wavelength of about 550 nm) that is preferably less than about 1.5, more preferably from about 1.38 to about 1.45, and most preferably from about 1.45 to about 1.46.

[0025] The term "anti-static" refers to the ability of a material not to retain or develop an appreciable amount of electrostatic charge. With nespect to an optimalmic lass coated with the anti-reflection coating of the present invention, the lens surface preferably remains substantially electrostatically neutral wherein the coated lens surface has an electric potential that is less than about 100 volts, more preferably less than about 75 volts, and most preferably less than about 50 volts, when measured in the neutral state or discharged state. Sy "neutral state" or "discharged state" is meant that the lens surface has not been subject to friction or other electrostatic charge generating processes or devices within about 5 seconds prior to measurement. Conversely, the "charged state" refers to the condition of a lens immediately, and up to about 5 seconds, after being subject to friction or other electrostatic charge generating processes or devices.

[0026] Preferably, for an ophthalmic lens coated with the anti-reflection coating, the coated lens surface has an electric potential that is less than about 600 volts, and preferably about 0 to about 500 volts, and most preferably about 0 to about 500 volts or less when measured immediately after being rubbed with a cloth made of a synthetic (e.g., polyester) or natural (e.g., cotton) material. Further, for an ophthalmic lens coated with the anti-reflection coating, preferably, the coated lens surface has an electric potential that is less than about 100 volts, more preferably about 0 to about 75 volts or less, and most preferably about 0 to about 75 volts or less, and most preferably about 0 to about 75 volts or less, and most preferably about 0 to about 75 volts or less, and most preferably about 0 to about 50 volts or less within about 5 seconds after being rubbed. As is apparent, one of the leatures of the inventive AR coating is its ability to discharge or dissipate electric charge and prevent charge buildup.

[0027] For purposes of this invention, volts shall include the magnitudes of both positive and negative voltages so that a lens surface having an electric potential of 100 volts or less, covers the range from -100 to +100 volts.

[0028] A preferred method of fabricating a conductive AR coating is to employ electrically conductive high and low refractive index materials that comprise metal oxides. Metal oxides with high refractive indices include, for example, oxides of titanium, cerium, bismuth, zinc, iron, niobium, tantalum, zirconium, chromium, tin, indium, and mixtures there-of. Particularly preferred electrically conductive high refractive index materials are niobium oxides and tilanium oxides derived by reactive sputtering or evaporation. Metal oxides with low refractive indices include, for example, oxides of silicon; suitable low refractive index materials also include aluminum oxyfluoride and magnesium oxyfluoride. Alternatively, one or more of the metal oxide materials can be replaced with on-oxide materials having the requisite refractive index. For instance, zinc suitide can be used in electrically conductive high refractive index material and angresium

fluoride and thorium fluoride can be employed in electrically conductive low refractive index materials. These nonoxides are described in U.S. Patent 5.332.618.

[0029] The multilayer film, which forms the inventive AR coating, comprises at least one layer that is electrically conductive. It is believed that the presence of the one or more electrically conductive layer effectively prevents appreciable electrostatic charge buildup by continuously discharging the same. The result is an AR coating which is anti-static. [0030] The terms "electrically conductive high refractive index material" and "electrically conductive low refractive index material" in electrically conductive low refractive index materials that are suitable for use in conductive anti-reflection coatings. Preferably, an electrically conductive high refractive index material comprises a metal oxide having a high refractive index. Conversely, an electrically conductive low refractive index material comprises a metal oxide having a low refractive index.

[0031] According to the Invention, the method of fabricating such materials is to synthesize a metal oxide in an environment so that the metal oxide film produced is non-stolchiometric or sub-oxidized. The resulting metal oxide film has the electrical properties described above.

[0032] As further described herein, in non-stoichiometric metal oxides the ratio of oxygen to metal is less than the fineoretical stoichiometric ratio for any particular structure. (Metal oxides wherein the ratio of metal to oxygen is stoichiometric are generally referred to as dielectric materials that are non-electrically conductive.) However, the electrically conductive materials can also comprise a mixture of (1) stoichiometric metal oxides and (2) stoichiometric oxides and or non-reacted metal atoms. Methods of synthesizing non-stoichiometric metal oxides include reactive sputtering and evaporating of metal in oxygen deficient environments.

[0033] It is known that stoichiometric titanium dioxide (i.e., TiO₂) has a specific conductivity of less than 10⁻¹⁰ S/cm whereas TiO_{1.9995} yields a value of 10⁻¹ S/cm. Thus it is expected that suitable electrically conductive high refractive index materials can be flabricated by reacting titanium with a non-stoichiometric amount of oxygen such that the titanium oxide produced has the nominal formula TiO₂ wherein x is less than 2, preferably about 1.3 to about 1.9995, more preferably about 1.50 to about 1.9995, and most preferably about 1.790 to about 1.9995.

[0034] It is believed that TiO₂ is the predominant form of titanium oxide formed. However, it is believed that other forms are produced as well. Thus, unless otherwise stated, TiO₂ will represent all forms of titanium oxide produced. It should be noted that when employing titanium oxides as the layer of electrically conductive high refractive index material, the particular structure of the titanium oxides produced is not critical so long as the layer has the desired optical \$\frac{1}{2}\$ characteristics**[eq. 7], criferative index and transparency) necessary for the anti-reflection coating, and the coated oph-thalmic lens has the anti-static properties defined above.

[0035] When the inventive AR coating is a multilayer film comprising a layer of electrically conductive low refractive index materials, it is expected that suitable electrically conductive low refractive index materials can be fabricated by reacting sillicon with a non-stoichiometric amount of oxygen such that the silicon oxide has the nominal formula SiO_X --wherein x is less than 2, preferably about 1.5 to about 1.99, more preferably about 1.7 to about 1.99 and most preferably 1.8 to about 1.99.

[0038] Similarly, it is believed that SiO₂ is the predominant form of silicon oxide formed. However, it is believed that other forms are produced as well. Thus, unless otherwise stated, SiO₂ will represent all forms of silicon oxides produced. Likewise, when employing silicon oxides as the layer of electrically conductive low refractive index material, the particular structure of the silicon oxides produced is not critical so long as the layer has the desired optical characteristics necessary for the enti-reflection coating and the coated optimalmic lone has the enti-static properties.

[0037] Thus, in general, when employing metal oxide materials to construct either a layer of low or high refractive index material, the particular formula or structure of the metal oxide is not critical so long as the layer has the desired optical properties. In the case of forming a layer of electrically conductive low or high refractive index material, the other criterion is that the anti-reflection coating has the anti-static properties.

[0038] Since only one or more layers of the multilayer film of the inventive AR coaring needs to be electrically conductive, it is understood that, except in the case where all the layers are electrically conductive, the other non-electrically conductive layer(s) of the film can comprise conventional dielectric materials such as titanium dioxide for the high refractive index layer and silicon dioxide for the low refractive index layer, it is further understood that the term "metal oxide" or "metal oxides" generally refers to both electrically conductive and nonconductive metal oxides. Thus, for instance, titanium oxides comprise electrical conductive TiQ, as defined above as well as titanium dioxide (i.e., TiO₂) a dielectric. Similarly, silicon oxides comprise electrical conductive SiQ, as defined above as well as silicon dioxide (i.e., SiQ-), a dielectric.

[0039] In designing and fabricating the multilayer film of an anti-reflection coating, selection of the material(s) for the electrically conductive layer should take into account the electrical conductivities of the various metals available to form suitable metal oxides. Preferably, the electrically conductive high or low refractive materials should be formed from metals having the higher electrical conductivity.

[0040] A further method of fabricating electrically conductive materials is to first produce the metal oxide dielectric films and thereafter introduce dopants into the film. The dopant is selected from conductive materials that can be the

same material as the metal. This technique is particularly suited if a non-oxide (e.g., MgF₂) is employed. The dopant can be introduced by any suitable menans including diffusion and ion implantation. See, for example, Wolf & Tauber, "Silicon Processing for the VLSI Era,* Vol. 1, pp. 242-332 (1986).

5 Methodology

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[0041] -The substantially transparent multilayer film structure of the inventive AR coating can be fabricated by conventional film deposition techniques (chemical and physical) including reactive sputter deposition, chemical vapor deposition and electron beam evaporation, with and without ion assist. These techniques are described in "Thin Film Processes" and "Thin Film Processes" in "Vossen & Kern, editors (1978 and 1991) Academic Press. The method most suited will depend on, among other things, the substrate (material and size) and the particular conductive metal oxides employed.

[0042] Sputtering techniques involve the physical ejection of material from a target as a result of ion bombardment. The ions are usually created by collisions between gas atoms and electrons in a glow discharge. The ions are accelerated into the target cathods by an electric field. A substrate is placed in a suitable location so that it intercepts a portion of the ejected atoms. Thus, a coating is deposited on the surface of the substrate. In reactive sputtering, a reactant gas forms a compound with the material which is sputtered from the target. When the target is slicion and the reactive gas is oxygen, for instance, silicon oxides, usually in the form of SiO₂ is formed on the surface of the substrate. Another sputtering technique is to first form a sputtered metal layer on a substrate and thereafter expose this layer to a reactive gas (e.g., oxygen) to form a metal oxide. Sputtering devices are described for instance in U.S. Patents 5,047,131, 4,651,095 and 4,166,018.

[0043] Chemical vapor deposition is the formation of a non-volatile solid film on a substrate by the reaction of vapor phase chemicals (feactants) that contain the required constituents. The reactant gases are introduced into a reaction chamber and are decomposed and reacted by a heated surface to form the thir film.

[0044] The conditions required to effect such depositions are well known in the art. For example, chemical vapor deposition, including low-pressure chemical vapor deposition (LPCVD), plasma enhanced chemical vapor deposition (PECVD), photon-induced chemical vapor deposition (PHCVD), and the like, is described by Wolf & Tauber, "Silicon Processing for the VLSI Era," Vol. 1, pp. 161-197 (1986).

[0045] Other suitable film deposition techniques include electron beam evaporation and ion-assisted deposition. In electron beam evaporation, an evaporation source (i.e., electron beam) is employed to vaporize the desired target material. The evaporated atoms condense on a substrate situated within the vacuum chamber. See, "Thin Film Processes II" at pages 79-132. In ion-assisted deposition, low-energy ion bombardment of the substrate surface during deposition of evaporated atoms provides surface cleaning, improved nucleation and growth, and in situ annealing which produces evaporated ocatings of improved quality. For a discussion of ion-assisted deposition, see Stelmack, et. al., "Review of Ion-Assisted Deposition: Research to Production" Nuclear Instruments and Methods in Physics Research B37/38 (1989) 787-793.

[0046] A preferred embodiment of the invention is illustrated in Fig. 1 which comprises an ophthalmic lens 10 that has a conductive anti-reflection coating disposed on a surface. The coating comprises four transparent, substantially coloriess layers 11-14 which hare formed of at least two different materials, in which one is a high refractive index material and the other is a low refractive index material. Layers 11-14 comprise an anti-reflection coating which is also referred to as an "AR stack" or "stack". Preferably, prior to forming the AR stack, an adhesion layer 10A comprising chromium oxides is deposited on the substrate surface.

[0047] Preferably, the AR stack or coaling comprises alternating high and low refractive index materials such that each layer has a refractive index different from that of any adjoining layer. Preferably, the index of refraction of each low refractive index material is less than about 1.5 at a wavelength of about 550 nm, which is a preferred designed wavelength for visible light transmission; the index of refraction of each high refractive index material is greater than about 2.0 at a wavelength of about 550 nm, and, each layer comprises a electrically conductive metal oxide. The first layer of the AR stack, which is formed on the substrate (or on the adhesion promotion layer, which is optional) normally comprises a high index material.

[0048] In the embodiment as shown in Fig. 1, layers 11 and 13 comprise high refractive index materials, wherein layer 11 has a thickness of about 7 m to about 15 mm, more preferably from about 9 mm to about 13 mm and most preferably from about 10 mm to about 12 mm and wherein layer 13 has a thickness of about 90 mm to about 130 mm, more preferably from about 100 mm to about 120 mm and most preferably from about 105 mm to about 115 mm. Layer 11 is designated the first layer of this 4 layer stack. Conversely, layers 12 and 14 comprise a low refractive index material wherein layer 12 has a thickness of about 15 mm to about 40 mm, more preferably from about 20 mm to about 35 mm, and most preferably from about 20 mm to about 40 mm, more preferably from about 55 mm to about 105 mm, more preferably from about 55 mm to about 105 mm, more preferably from about 45 mm to about 45 mm, and wherein layer 14 has a thickness of about 155 mm to about 105 mm, more preferably from about 75 mm to about 85 mm.

[0049] The multilayer film forming the AR coating can comprise any suitable number of layers of high/low refractive index materials. For most optical applications, it is desirable that the AR coating reduce the surface reflectance to an extremely low value over an extended spectral region so as to maintain the proper color balance. The number of layers will depend on, among other things, the substrate material, the particular anti-reflection properties desired and compositions of the high and low refractive index materials used. Generally, greater anti-reflection can be achieved by increasing the number of layers of alternating high and low refractive index layers but there is a concomitant decrease in the spectral region of anti-reflection. Purthermore, as described, in U.S. Patents 3,432,225 (3-layer design), 3,565,599 (4-layer design), and 5,332,618 (8-layer design), mathematical formulas have been developed to simulate the optics of multilayer anti-reflection coatings so that their design can be optimized.

Experimental

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[0050] The electron beam ion-assisted deposition apparatus employed to produce AR stacks of the present invention is shown in Fig. 2 and comprises a vacuum chamber 100 which contains ion gun 102 and electron beam evaporation source 106 that are positioned at the base of the vacuum chamber. Baffle 108 separates the ion gun from the E-beam source. Located at the upper portion of the chamber are lens dome 112 and substrate support 110. The vacuum chamber is available from Balzer Ltd., Balzer, Licethenstein, as model Balzer 1200 Box Coater, it is equipped with a Balzer EBS 420 Electron Beam source. The ion gun is a Commonwealth mark II Ion Source from Commonwealth Scientific Corp., Alexandria, Virginia.

[0051] In operation, a substrate (e.g., ophthalmic lens) is placed on the substrate support and thereafter a vacuum is created and maintained with vacuum pump 114. Initially, the long un shutter 104 is closed to prevent ion energy from striking the substrate until the ion gun has stabilized to the preset energy level. Similarly, shutter 113 covers the E-beam source until the target is about to evaporate. Argon is employed as the ionizing gas for the ion gun. Normally, the substrate surface is subject to ion etch prior to deposition of the chromium oxide adhesive layer. To produce a metal oxide layer, the E-beam source is activated to produce a metal evaporant of the requisite concentration. Oxygen from oxygen source 116 reacts with the evaporant to form metal activated would which is deposited on the substrate surface. Subsequent metal oxide layers are produced in a similar manner.

[0052] AR coatings having the structure as shown of Fig. 1 were fabricated with the device of Fig. 2. Representative operating parameters in the fabrication of a preferred AR coating and the characteristics of the individual layers are set forth in Table 1. The substrates used were laminated single vision lenses each having a scratch resistant coating.

TABLE 1

	TABLE 1						
35		Material	Thickness (nm)	Index @ 550 nm	QWOT*	O ₂ Pressure (mbar)	Deposition rate (nm/sec)
	Adhes. Layer	Chromlum oxide	<1.0	~2.50		8 x 10 ⁻⁵	
	Layer 1	Titanium oxide (TiO _x)	11.33	2.271	0.1871	2 x 10 ⁻⁴	0.3
10	Layer 2	Silicon dioxide (SiO ₂)	27.30	1.461	0.2901		0.8
	Layer 3	Titanium oxide (TiO _x)	111.07	2.271	1.8344	2 x 10 ⁻⁴	0.3
5	Layer 4	Sillcon dioxide (SiO ₂)	80.91	1.461	0.8597		0.8

*Quarter Wave Optical Thickness

[0053] Prior to commencing deposition, the lens substrates were ultrasonically cleaned using deionized water and then degassed at 95°C for 2 hours. Thereafter, lenses were loaded on the substrate support and the pressure in the chamber was lowered to about 6 x 10° mbar. The substrate surface was ion etched for approximately 4 minutes with the ion gun operating at 0.9 A/110 V. In forming the adhesive layer, chromium target material was initially covered with shutter 113 as the chromium is heated by the electron beam from the E-beam evaporation source. The shutter was removed before the chromium evaporated. During the formation and deposition of the chromium oxide layer, oxygen was introduced sufficient to raise and maintain the chamber pressure to 8 x 10° mear. As is apparent, the ion gun shutter was also removed during deposition. The succeeding 4 layers that comprise the AR coating were deposited in

a similar manner. Preferably, the overall pressure of the vacuum chamber is maintained at about 2 x 10⁴ mbar or less throughout the deposition of each of the layers. The second litanium oxide layer (layer 3) of the AR coating formed was found to be electrically conductive.

[0054] Lenses coated with the inventive AR coating of Table 1 were tasted for anti-static properties. To induce electrostatic charge buildup, the coatings were rubbed with a lint-free cotton cheescolth and a 100% polyester Luminex® (Toray Industries, Inc., Tokyo, Japan) lens cleaning cloths. Measurements were conducted in two separate environments: with and without air conditioning. Air conditioning tends to reduce the amount of moisture in the air and thereby affect static properties. Three measurements were made for each lons. Prior to any rubbing, the lenses were taken out of their packaging and allowed to acclimate to the environment for at least 30 minutes. The voltages on the front surfaces were then measured with a 11 300 static meter (Static Control Services, Inc., Palm Springs, CA). Next, each lens was rubbed for ten strokes (pack and forth - four inches each way) on the appropriate cloth, and the electrostatic measurement was made immediately. The third measurement was made following a five seconds interval after the lenses were rubbed. Between each measurement, the lenses were placed in front of an Endstat 2000 Deionizer (Static Control Services, Inc.) to eliminate any residual static charges.

[0055] The measurements, which are set forth in Table 2, demonstrate that lenses coated with the inventive AR coating developed insignificant or no electrostatic charge.

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TABLES

	THOLE L				
	NO RUB	RUB	RUB + 5 SEC		
Without Air Conditioning					
Cotton Cheesecloth	0	-50	0		
Polyester Cloth	0	100	0		
With Air Conditioning					
Cotton Cheesecloth	0	-100	-25		
Polyester Cloth	0	0	0		
(Measurements were made in volts)					

[0056] Laminated single vision lenses each having a scratch resistant coating and coated with conventional antireflection coatings that included a hydrophobic outer layer were also tested for anti-static properties in the manner described above. These "stock" lenses were available from various ophthalmic lens manufacturers. The results are shown in Tables 3 through 6. The degree of hydrophobicity of the outer surface of each AR coating is proportional to its contact ancie which was measured with a Tantec Anole Meter, available from Tantee inc. Schaumbero.

[0057] Tables 3 (cotton cheesecloth) and 4 (polyester cloth) comprise measurements taken in a room without air conditioning. Similarly, Tables 5 (cotton cheesecloth) and Table 6 (polyester cloth) comprise measurements taken in one with air conditioning. (Measurements were made in volts). As is apparent, lens number 1 in each of Tables 3-6 corresponds to the appropriate inventive lens in Table 2. Lens 2-7 of Table 3 had the same anti-reflection coatings as lens 2-7 of Table 4, respectively. Similarly, lens 2-9 of Table 5 had the same anti-reflection coatings as lens 2-9 of Table 6, respectively.

[0058] As is apparent from the comparative data, the inventive AR coating demonstrated superior anti-static properties compared to the prior art anti-reflection coatings available from ophthalmic lens manufacturers. Furthermore, the inventive AR coating does not require an outer hydrophobic coating which is present in all of the conventional AR coating steated.

TABLE 3

Lenses	Lenses No Rub R		Rub +5 sec	Contact Angle
1	0	-50	0	31°
2	-150	-700	-200	100°
3	0	-950	-300	95°
4	-250	-1000	-500	100°
5	-213	-2375	-1000	95°
6	-350	-3250	-2000	95°
7	-700	-4500	-2000	81°

TABLE 4

Lenses	No Rub	Rub	Rub +5 sec	Contact Angle
1	0	100	0	31°
2	-150	-950	-325	100°
3	0	-1350	-150	95°
4	-250	-1000	-500	100°
5	-213	-4500	-2750	95°
6	350	-5500	-4000	95°
7	-700	-3000	-2250	81°

TABLE 5

Lenses	No Rub	Rub	Rub +5 sec	Contact Angle	
1	0	-100	-25	31°	
2	-100	-800	-500	100°	
3	-150	-1750	-850	100°	
4	0	-2000	-700	95°	
5	-450	-3500	-2250	81°	
6	-163	-4500	-3250	95°	
7	-500	-6500	-5000	95°	
8	-250	-8500	-6000	100°	
9	-1250	-10000	-9500	95°	

TARLE 6

Lenses	No Rub	Rub	Rub +5 sec	Contact Angle
1	0	0	0	31°
2	-100	-2250	-450	95°
3	-150	-1250	-600	100°
4	0	-2750	-650	100°
5	-163	-4500	-2250	81°
6	-500	-5875	-3500	95°
7	-450	-10000	-6000	95°
8	-250	-8000	-5000	100°
9	-1250	-10000	-9500	95°

Layer-by-layer Analysis of AR Coating

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[0059] To determine what significant effect, if any, the individual layers of the AR coating had on the anti-static properties of AR coatings, a layer-by-layer analysis of the AR coating having the five layer structure described in Table 1 was conducted. In this analysis, five plastic front wafers were coated, each having a different number of layers. (The wafers used were plastic and coated with a scratch resistant polymeric layer.) The first wafer was coated with (1) the chromium oxide adhesion layer only. The second wafer was coated with (1) the chromium oxide adhesion layer and (2) first TO₂, and so on, so that the fifth wafer comprised the five layer structure.

[0060] After formation of the five coaled wafers, the voltage on the front surfaces of each wafer was measured with a Ti 300 static meter. Each wafer was rubbed for ten strokes (back and forth - four inches each way) on a lint-free cotton cheesecloth and the measurements were made immediately. In the third test, five seconds lapsed after the lenses were rubbed, before being measured. As a control, the electrostatic voltages of two plastic front wafers (i.e., controls 1 and 2) were also measured. Each control wafer was coaled with a different scratch resistant polymeric coation. The five wafers tested had the same scratch resistant polymerosting as control?

[0061] It was found that the electrostatic charge remained high for the first, second, and third wafers; however, the fourth wafer which comprised: (1) the chromium oxide adhesive layer, (2) the first TiO_x layer, (3) the first SiO₂ layer,

and (4) the second TiO, layer, showed a dramatic reduction is electrostatic charge. Analysis showed that for the second TiO, alyer, x was about 1.78. Thus, at least with respect to AR coatings having alternating high and low refractive index materials comprising titanium oxides and silicon oxides, the second high refractive index material preferably is TiO_x wherein, x is about 1.3 to about 1.9995, more preferably about 1.5 to about 1.9995, and most preferably about 1.7 to about 1.9995.

[0062] It should be emphasized that while the examples shown herein comprise only two different high and low index materials (i.e., SiO₂ and TiO₂) in the particular design, similar anti-reflection coating structures could be designed with two or more high index materials and/or two or more low index materials, or even a material such as aluminum oxide of some intermediate refractive index.

[0063] Furthermore, in certain cases, it may be advantageous to use mixtures of materials or complex compounds. A mixture of cerium oxide and zinc oxide could be used for the high index films and a mixture of silicon dioxide and magnesium fluoride for the low index films. Other mixtures might be chosen to suit a particular deposition technique or to take advantage of a particular optical or physical property of a material.

[0064] Ophthalmic lens having the anti-reflection coating preferably has a transmittance at 550 nm of between about 5 98.0 to about 99.5%, more preferably between about 99.5 to about 99.5%, and most preferably between about 99.0 to about 99.5%. Moreover, the ophthalmic lens has a reflectance at 550 nm of between about 0.5 to about 2.0%, more preferably between about 0.5 to about 1.0%, and most preferably between about 0.5 to about 1.0%.

[0063] Although only preferred embodiments of the invention are specifically disclosed and described above, it will be appreciated that many modifications and variations of the present invention are possible in light of the above teachings and within the purview of the appended claims without departing from the scope of the invention.

Claims

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25 1. A method of fabricating a high transmittance article which comprises the steps of:

providing a transparent substrate (10); and forming, on a surface of said substrate, a transparent, electrically conductive anti-reflection coating (11, 12);

30 characterized in that the step of forming said coating comprises reacting metal with non-stoichiometric amounts of oxygen such that the coating comprises one or more layers of electrically conductive metal oxide material.

- The method of claim 1 wherein the transparent, electrically conductive anti-reflection coating (11, 12) comprises
 multiple layers wherein at least one layer comprises an electrically conductive high refractive index material (11)
 or an electrically conductive low refractive index material (12).
- The method of claim 2 wherein each of the electrically conductive layers is formed by electron beam ion evaporation or reactive sputiering whereby metal reacts with non-stoichiometric amounts of oxygen such that the each layer comprises an electrically conductive metal oxide.
- 4. The method of claim 2 or 3 wherein the multilayer anti-reflection coating comprises alternating high and low refractive index materials such that each layer has a refractive index different from that of any acjoining layer, wherein the index of refraction of each low refractive index material is less than 1.5 at a wavelength of 550 nm, wherein the index of refraction of each high refractive index material is greater than 2.0 at a wavelength of 550 nm, and wherein at least one layer comprises an electrically conductive metal oxide material.
- 5. The method of any of claims 2 to 4 wherein the multilayer anti-reflection coating comprises:
 - (i) a first layer (11) having an index of refraction from 2.0 to 2.55 and that is 7 to 15 nm thick;
 - (ii) a second layer (12) having an index of refraction from 1.38 to 1.5 and that is 15 to 40 nm thick;
 - (iii) a third layer (13) having an index of refraction from 2.0 to 2.55 and that is 90 to 130 nm thick; and
 - (iv) a fourth layer (14) having an index of refraction from 1.38 to 1.5 and that is 55 to 105 nm thick, wherein the indices of refraction are measured at a reference wavelength of 550 nm.
- The method of claim 5 wherein the third layer is electrically conductive.
 - The method of claim 5 or 6 further comprising the step of depositing an adhesion layer (10A) onto the substrate surface prior to forming said first layer.

8. A high transmittance article comprising:

a transparent substrate (10); and a transparent, electrically conductive anti-reflection coating (11, 12)

characterized in that the anti-reflection coating comprises one or more electrically conductive layers of non-strickly metal oxide material

9. The article of claim 8 wherein

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the anti-reflection coating is a transparent multilayer film comprising alternating layers of high refractive index materials (11, 12, 13, 14), wherein one or more layers is electrically conductive comprising said non-stoichiometric metal oxides.

10. The article according to any of the preceding claims 8 or 9 wherein

the anti-reflection coating comprises alternating high and low refractive index materials such that each layer has a refractive index different from that of any adjoining layer, wherein the index of refraction of each low refractive index material is less than 1.5 at a wavelength of 550 nm, wherein the index of refraction of each high refractive index material is greater than 2.0 at a wavelength of 550 nm.

- 20 11. The article according to any of the preceding claims 8 to 10 wherein the anti-reflection coating comprises:
 - (i) a first layer (11) having an index of refraction from 2.0 to 2.55 and that is 7 to 15 nm thick.
 - (ii) a second layer (12) having an index of refraction from 1.38 to 1.5 and that is 15 to 40 nm thick;
 - (iii) a third layer (13) having an index of refraction from 2.0 to 2.55 and that is 90 to 130 nm thick; and
 - (iv) a fourth layer (14) having an index of refraction from 1.38 to 1.5 and that is 55 to 105 nm thick, wherein the indices of refraction are measured at a reference wavelenoth of 550 nm.
 - 12. The article of claim 11 wherein the third layer is electrically conductive.
 - The article of claim 11 or 12 further comprises an adhesion layer (10A) situated between the substrate surface and first layer.
- 14. The article according to any of the preceding claims 8 to 13 wherein the transparent substrate comprises an oph-
 - 15. The article of claim 14 wherein the ophthalmic lens in the neutral state has an electric potential 100 volts or less, wherein neutral state denotes that the lens has not been subject to electrostatic charge generating processes or devices within 5 seconds to measurement of said electric potential.

Patentansprüche

1. Verfahren zur Herstellung eines Gegenstandes hohen Transmissionsgrades, enthaltend die Schritte:

Bereithalten eines transparenten Substrates (10) und

Ausbilden einer transparenten, elektrisch leitenden Antireflexionsbeschichtung (11,12) auf einer Fläche des Substrats,

50 dadurch gekennzeichnet,

daß der Schritt des Ausbildens der Beschichtung das Reagieren von Metall mit nicht-stöchiometrischen Mengen von Sauerstoff umfalt, so daß die Beschichtung eine oder mehrere Schichten von elektrisch leitendem Metallozi

Verfahren nach Anspruch 1,

wobei die transparente, elektrisch leltende Antireflexionsbeschichtung (11,12) mehrfache Schichten enthält, wobei wenigstens eine Schicht ein elektrisch leitendes Material (11) mit hohem Brechungsindex oder ein elektrisch leitendes Material (12) mit niedrigem Brechungsindex enthält.

- 3. Verfahren nach Anspruch 2.
 - wobei jede der elektrisch leitenden Schichten durch Elektronenstrahlionenverdampfung oder reaktives Zerstäuben geformt ist, wobei Metall mit nicht-stöchiometrischen Mengen von Sauerstoff reagiert, so daß jede Schicht ein elektrisch leitendes Metallodig enthält.
- Verfahren nach Anspruch 2 oder 3.

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wobei die mehrschichtige Antireflexionsbeschichtung abwechselnde Materialien eines hohen und eines niedrigen Brechungsindex aufwelst, so daß jede Schicht einen Brechungsindex hat, der verschieden ist von demjenigen jeder anliegenden Schicht, wobei der Brechungsindex jedes Materialis mit einderigem Brechungsindex kleiner ist als 1,5 bei einer Wellenlänge von 550 nm, wobei der Brechungsindex jedes Materials hohen Brechungsindexes größer ist als 2,0 bei einer Wellenlänge von 550 nm, und wobei wenigstens eine Schicht ein elektrisch leitendes Metalloxidmaterial enthält.

 Verfahren nach jedem der Ansprüche 2 bis 4, wobei die mehrschichtige Antireflexionsbeschichtung enthält:

- (i) eine erste Schicht (11) mit einem Brechungsindex von 2,0 bis 2,55, die 7 bis 15 nm dick ist;
- (ii) eine zweite Schicht (12) mit einem Brechungsindex von 1,38 bis 1,5, die 15 bis 40 nm dick ist;
- (iii) eine dritte Schicht (13) mit einem Brechungsindex von 2,0 bis 2,55, die 90 bis 130 nm dick ist und (w) eine verte Schicht (14) mit einem Brechungsindex von 1,36 bis 1,5, die 55 bis 105 nm dick ist, wobel die Brechungsindizes bei einer Referenzwellenlänge von 550 nm gemessen sind.
- Verfahren nach Anspruch 5,

wobei die dritte Schicht elektrisch leitend ist.

- Verfahren nach Anspruch 5 oder 6, ferner enthaltend den Schritt des Aufbringens einer Klebeschicht (10A) auf die Substratfläche vor dem Ausbilden der ersten Schicht.
- 8. Gegenstand eines hohen Transmissionsgrades enthaltend:

ein transparentes Substrat (10) und eine transparente, elektrisch leitende Anti-reflexionsbeschichtung (11,12),

dadurch gekennzelchnet, daß die Antireflexionsbeschichtung eine oder mehrere elektrisch leitende Schichten aus nicht-stöchiometrischem Metalloxidmaterial enthält.

Gegenstand nach Anspruch 8.

wobei die Antireflexionsbeschichtung ein transparenter Mehrschichtlilm ist mit abwechseinden Schichten von Materiallen (11,12,13,14) eines hohen Brochungsindex, wobei eine oder mehrere Schichten elektrisch leitend sind und die nicht - stöchicmetrischen Metalloxide enthält.

10. Gegenstand nach jedem der vorhergehenden Ansprüche 8 oder 9.

wobei die Antireflexionsbeschichtung abwechselnd Materialien eines hohen und eines niedrigen Brechungsindex enthält, so daß jede Schicht einen Brechungsindex hat, der verschieden ist von jeder anliegenden Schicht, wobei der Brechungsindex jedes Materials mit niedrigem Brechungsindex kleilen: eit at 1, 5 bei einer Weilenlänge von 550 mm, wobei der Brechungsindex eines jeden Materials mit hohem Brechungsindex größer ist als 2,0 bei einer Weilenlänge von 550 mm.

 Gegenstand nach jedem der vorhergehenden Ansprüche 8 bis 10, wobei die Antireflexionsbeschichtung enthält:

(i) eine erste Schicht (11) mit einem Brechungsindex von 2,0 bis 2,55, die 7 bis 15 nm dick ist.

- (ii) eine zweite Schicht (12) mit einem Brechungsindex von 1,38 bis 1,5, die 15 bis 40 nm dick ist,
- (iii) eine dritte Schicht (13) mit einem Brechungsindex von 2,0 bis 2,55, die 90 bis 130 nm dick ist und
- (iv) eine vierte Schicht (14) mit einem Brechungsindex von 1,38 bis 1,5, die 55 bis 105 nm dick ist, wobei die Brechungsindizes bei einer Referenzwellenlänge von 550 nm gemessen sind.
 - Gegenstand nach Anspruch 11, wobei die dritte Schicht elektrisch leitend ist.

- Gegenstand nach Anspruch 11 oder 12, ferner enthaltend eine Klebeschicht (10A), die sich zwischen der Substratfläche und der ersten Schicht befindet.
- Gegenstand nach jedem der vorhergehenden Ansprüche 8 bis 13, wobei das transparente Substrat ein Brillenglas enthält.
- 15. Gegenstand nach Anspruch 14, wobei das Brillenglas in dem neutralen Zustand ein elektrisches Potential 100 V oder weniger hat, wobei der neutrale Zustand bezeichnet, daß die Linse nicht elektrostatischen Ladungserzeugungsprozessen oder Vorrichtungen innerhalb 5 sec bis zu Messung des elektrischen Potentials unterworfen worden ist.

Revendications

(11, 12);

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Procédé pour la fabrication d'un article à coefficient de transmission élevé, qui inclut les étapes suivantes ;

l'apport d'un substrat transparent (10) et la formation, sur la surface dudit substrat, d'un revêtement transparent antireflet et électriquement conducteur

caractérisé en ce que l'étape de formation dudit revêtement comprend la réaction d'un métal avec des quantités non stoechiométriques d'oxygène de façon que le revêtement possède une ou plusieurs couches de matériau électriquement conducteur en oxygèm étallique.

- Procédé selon la revendication 1, dans lequel le revêtement transparent antireflet et électriquement conducteur (11, 12) comprend de multiples couches, dont au moins une contient un matériau électriquement conducteur à indice de réfraction élevé (11) ou un matériau électriquement conducteur à faible Indice de réfraction (12).
- 3. Procédé selon la revendication 2, dans lequel chacune des couches électriquement conductrices est formée par évaporation par faisceau d'électrons ou par pulvérisation cathodique réactive, où le métal réagit avec des quantités non stoechiométriques d'oxygène de façon que chaque couche renferme un oxyde métallique électriquement conducteur.
- 4. Procédé selon la revendication 2 ou 3, dans lequel le revêtement antireflet multicouches comprend des matériaux alternés à indice de réfraction élevé et faible de sorte que chaque couche possède un indice de réfraction différent de l'indice de totte couche adjacente, où l'indice de réfraction de chaque matériau à faible indice de réfraction est inférieur à 1,5 à une longueur d'onde de 550 nm, où l'indice de réfraction de chaque matériau à indice de réfraction élevé est supérieur à 2,0 à une longueur d'onde de 550 nm et où au moins une couche contient un matériau en oxyde métallique électriquement conducteur.
 - Procédé selon l'une quelconque des revendications 2 à 4, dans lequel le revêtement antireflet multicouches comprend:
 - (i) une première couche (11) avant un indice de réfraction de 2,0 à 2,55 et une épaisseur de 7 à 15 nm;
 - (ii) une deuxième couche (12) ayant un indice de réfraction de 1,38 à 1,5 et une épaisseur de 15 à 40 nm;
 (iii) une troisième couche (13) ayant un Indice de réfraction de 2,0 à 2,55 et une épaisseur de 90 à 130 nm et
 - (iii) the troisierne couche (13) ayant un indice de renaction de 2,0 à 2,35 et une épaisseur de 90 à 130 hin et
 - (iv) une quatrième couche (14) ayant un indice de réfraction de 1,38 à 1,5 et une épaisseur de 55 à 105 nm,
 - où les indices de réfraction sont mesurés à une longueur d'onde repère de 550 nm.
 - Procédé selon la revendication 5, dans lequel la troisième couche est électriquement conductrice.
 - Procédé selon la revendication 5 ou 6, comprenant en outre l'étape du dépôt d'une couche d'adhésion (10A) sur la surface du substrat avant la formation de ladite première couche.
 - 8. Article à coefficient de transmission élevé comportant :

un substrat transparent (10) et

un revêtement transparent antireflet et électriquement conducteur (11, 12),

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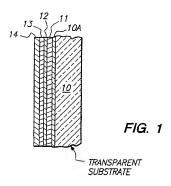
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caractérisé en ce que le revêtement antireflet contient une ou plusieurs couches électriquement conductrices de matériau non stoechiométrique d'oxyde métallique.

- 9. Article selon la revendication 8, dans lequel le revêtement antireflet est un film multicouches transparent ayant des couches alternées de matériaux à indice de réfraction élevé (11, 12, 13, 14), dans lequel une ou plusieurs couches sont électriquement conductrices et contiennent lesdits oxydes métalliques non stopehinefriques.
- 10 10. Article selon l'une quelconque des revendications 8 et 9 précédentes, dans lequel le revêtement antireflet est formé de matériaux atternés à indice de réfraction élevé et faible de sorte que chaque couche possède un dice de réfraction différent de l'indice de toute couche adjacente, où l'indice de réfraction de chaque matériau à riche de 15.5 à une longueur d'onde de 550 nm et où l'indice de réfraction de chaque matériau à rindice de réfraction deve set supérieur à 2,0 à une longueur d'onde de 550 nm.
 - 11. Article selon l'une quelconque des revendications 8 à 10 précédentes, dans lequel le revêtement antireflet comporte:
 - (i) une première couche (11) ayant un indice de réfraction de 2,0 à 2,55 et une épaisseur de 7 à 15 nm;
 - (ii) une deuxième couche (12) ayant un indice de réfraction de 1,38 à 1,5 et une épaisseur de 15 à 40 nm;
 - (iii) une troisième couche (13) ayant un indice de réfraction de 2,0 à 2,55 et une épaisseur de 90 à 130 nm et
 - (iv) une quatrième couche (14) ayant un indice de réfraction de 1,38 et 1,5 et une épaisseur de 55 à 105 nm,

où les indices de réfraction sont mesurés à une longueur d'onde repère de 550 nm.

- 12. Article selon la revendication 11, dans lequel la troisième couche est électriquement conductrice.
- 13. Article selon la revendication 11 ou 12, comprenant en outre une couche d'adhésion (10A) située entre la surface du substrat et la première couche.
- 14. Article selon l'une quelconque des revendications 8 à 13 précédentes, dans lequel le substrat transparent comprend une lentille ophtalmique.
- 15. Article selon la revendication 14, dans lequel la lentille ophtalmique à l'état neutre présente un potentiel électrique de 100 voits ou moins et où l'état neutre indique que la lentille n'a pas été soumise à des processus ou appareis générateurs de charge électrostatique dans un délai de 5 secondes avant la mesure dudit potentiel électrique.



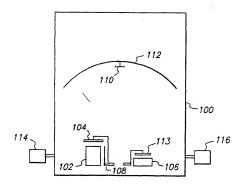


FIG. 2

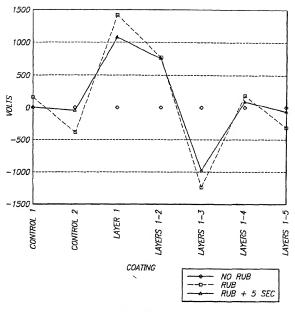


FIG. 3